ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Composit © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	ion of the s encompasse	ubstances es all lower	within the manufactur r level materials for wi	er listed i hich the n	tem. Note: if nanufacturer l	he item is an as as engineering	ssembly with lower responsibility.	
1752-21.1					Form Type Distribute						tials and Mfg Information				
Supplier Inforr	nation														
Company name* Co			Company unique ID			Unique ID Authority				Response Date*					
onsemi											2023-06-08				
Contact Name			Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Request	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing Site		Manufacturing Site		Weight*	UOM	Unit Type		
		MOC207M		8SO TR			2023-06-08		1	ТНН		168.58636	mg	Each	
Manufacturing	g Proccess Information	1													
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperatu		emperatur	ture Max Time at Peak Temp		ture Numbe	of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU A			U Alloy	loy 1			260 C		С	30 seco		nds 3			
Comments															
evel 1 - maximum	time at peak temperature of	luring sol	dering is 10-3	0 seconds											
for more informat	tion regarding material com	position j	olease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	nition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ry (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl BP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measur
Coupling Gel	4.18236	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.046	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		4.1364	mg
Die	4.043	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.283	mg
			Supplier	Silicon (Si)	7440-21-3		3.76	mg
Die Attach	0.754	mg	Supplier	Silver (Ag)	7440-22-4		0.6032	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.1508	mg
Lead Frame	59.197	mg	Supplier	Silver (Ag)	7440-22-4		0.148	mg
			Supplier	Zinc (Zn)	7440-66-6		0.071	mg
			Supplier	Iron (Fe)	7439-89-6		1.36	mg
			Supplier	Copper (Cu)	7440-50-8		57.6	mg
			Supplier	Phosphorus (P)	7723-14-0		0.018	mg
Mold Compound-White	98.06	mg		Epoxy resin	proprietary data		13.2381	mg
			Supplier	Phenol Resin	Proprietary Data		5.3933	mg
			Supplier	Titanium Dioxide (TiO2)	13463-67-7		24.515	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		2.9418	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.9418	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		49.03	mg
Plating	2.1	mg	Supplier	Tin (Sn)	7440-31-5		2.1	mg
Wire Bond - Au	0.25	mg	Supplier	Gold (Au)	7440-57-5		0.25	mg